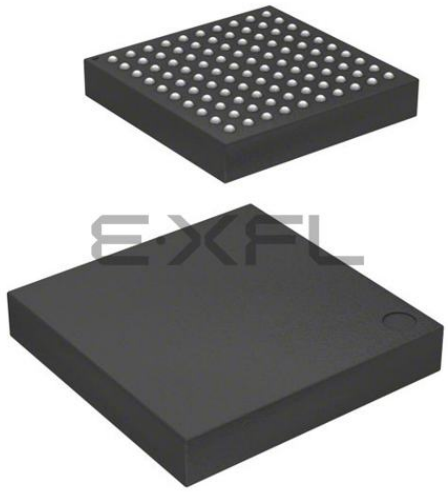
Renesas Electronics America Inc - R5F52106BDLJ#U0 Datasheet



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Applications of "Embedded - Microcontrollers"

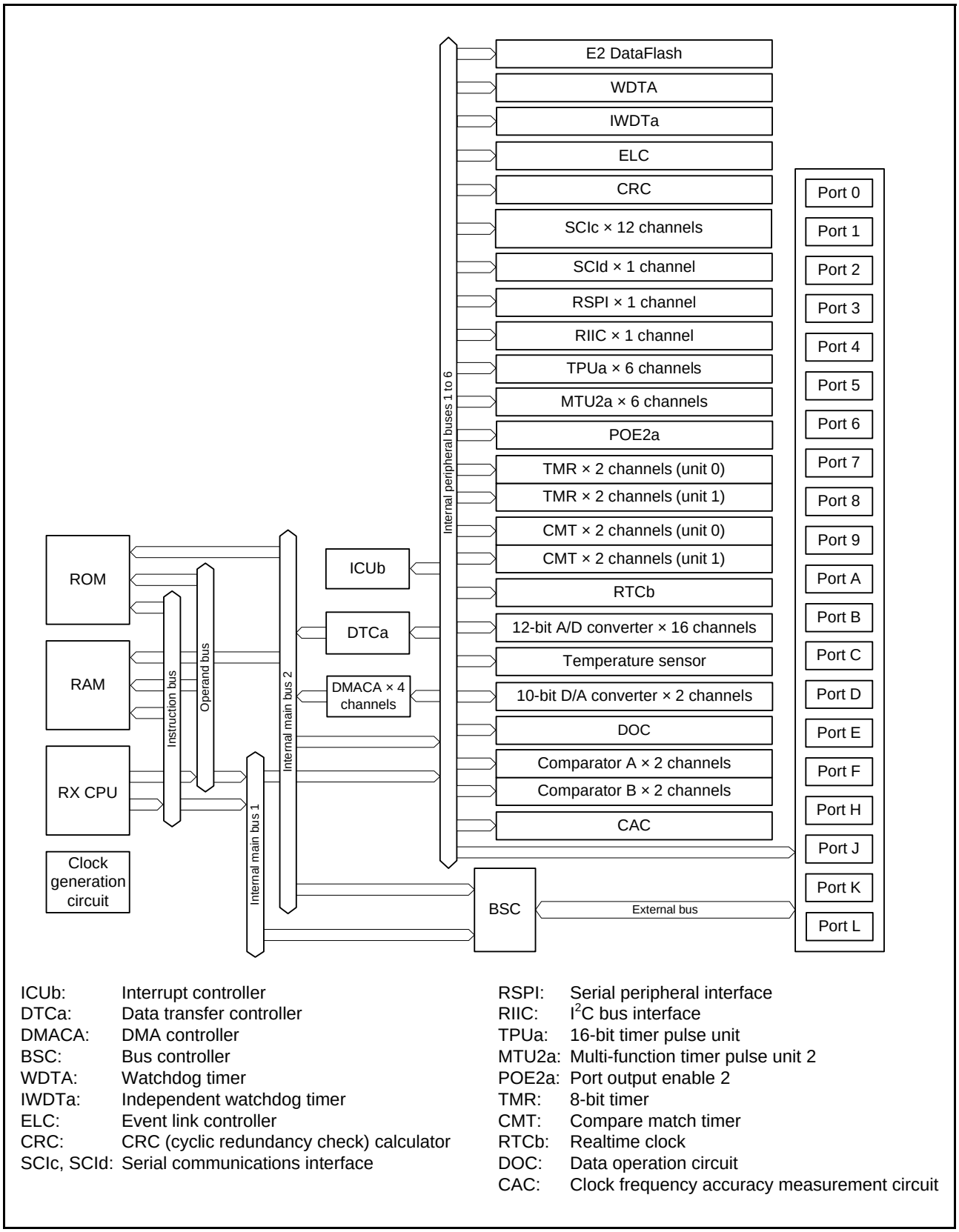
Details	
Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	EBI/EMI, I²C, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	84
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	1.62V ~ 5.5V
Data Converters	A/D 16x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f52106bdlj-u0

Table 1.1 Outline of Specifications (4 / 5)

Classification	Module/Function	Description
Communication functions	Serial communications interfaces (SCIc, SCId)	• 13 channels (channel 0 to 11: SCIc, channel 12: SCId) • Serial communications modes: Asynchronous, clock synchronous, and smart-card interface • On-chip baud rate generator allows selection of the desired bit rate • Choice of LSB-first or MSB-first transfer • Average transfer rate clock can be input from TMR timers (SCI5, SCI6, and SCI12) • Simple IIC • Simple SPI • Master/slave mode supported (SCId only) • Start frame and information frame are included (SCId only)
	I^2C bus interface (RIIC)	• 1 channel • Communications formats: I^2C bus format/SMBus format • Master/slave selectable • Supports the fast mode
	Serial peripheral interface (RSPI)	• 1 channel • Transfer facility Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPI clock (RSPCK) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) • Capable of handling serial transfer as a master or slave • Data formats • Choice of LSB-first or MSB-first transfer The number of bits in each transfer can be changed to any number of bits from 8 to 16, 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) • Double buffers for both transmission and reception
12-bit A/D converter (S12ADb)		• 12 bits (16 channels × 1 unit) • 12-bit resolution • Minimum conversion time: 1.0 μs per channel (in operation with ADCLK at 50 MHz) • Operating modes Scan mode (single scan mode, continuous scan mode, and group scan mode) • Sample-and-hold function • Self-diagnosis for the A/D converter • Assistance in detecting disconnected analog inputs • Double-trigger mode (duplication of A/D conversion data) • A/D conversion start conditions A software trigger, a trigger from a timer (MTU), an external trigger signal, or ELC
Temperature sensor (TEMPSa)		• Outputs the voltage that changes depending on the temperature • PGA gain switchable: Four levels according to the voltage range
D/A converter (DA)		• 2 channels • 10-bit resolution • Output voltage: 0 V to VREFH
CRC calculator (CRC)		• CRC code generation for arbitrary amounts of data in 8-bit units • Select any of three generating polynomials: $X^8 + X^2 + X + 1$, $X^{16} + X^{15} + X^2 + 1$, or $X^{16} + X^{12} + X^5 + 1$ • Generation of CRC codes for use with LSB-first or MSB-first communications is selectable.
Comparator A (CMPA)		• 2 channels • Comparison of reference voltage and analog input voltage
Comparator B (CMPB)		• 2 channels • Comparison of reference voltage and analog input voltage
Data Operation Circuit (DOC)		Comparison, addition, and subtraction of 16-bit data
Power supply voltage/Operating frequency		VCC = 1.62 to 1.8 V: 20 MHz, VCC = 1.8 to 2.7 V: 32 MHz, VCC = 2.7 to 5.5 V: 50 MHz
Operating temperature		D version: −40 to +85°C, G version: −40 to +105°C*2

1.3 Block Diagram

Figure 1.2 shows a block diagram.



ICUb: Interrupt controller
DTCa: Data transfer controller
DMACA: DMA controller
BSC: Bus controller
WDTA: Watchdog timer
IWDTa: Independent watchdog timer
ELC: Event link controller
CRC: CRC (cyclic redundancy check) calculator
SCIc, SCId: Serial communications interface
RSPI: Serial peripheral interface
RIIC: I^2C bus interface
TPUa: 16-bit timer pulse unit
MTU2a: Multi-function timer pulse unit 2
POE2a: Port output enable 2
TMR: 8-bit timer
CMT: Compare match timer
RTCb: Realtime clock
DOC: Data operation circuit
CAC: Clock frequency accuracy measurement circuit

Figure 1.2 Block Diagram

Table 1.10 List of Pins and Pin Functions (144-Pin LQFP) (1 / 4)

Pin No.	Power Supply, Clock, System Control	I/O Port	External Bus	Timers (MTU, TMR, POE)	Communications (SCIc, SCId, RSPI, RIIC)	Others
1	AVSS0					
2		P05				DA1
3	VREFH					
4		P03				DA0
5	VREFL					
6		P02		TMCI1	SCK6	
7		P01		TMCI0	RXD6/SMISO6/SSCL6	
8		P00		TMRI0	TXD6/SMOSI6/SSDA6	
9		PF5				IRQ4
10	NC					
11		PJ5				
12	VSS					
13		PJ3		MTIOC3C	CTS6#/RTS6#/SS6#/ CTS0#/RTS0#/SS0#	
14	VCL					
15		PJ1		MTIOC3A		
16	MD					FINED
17	XCIN					
18	XCOUT					
19	RES#					
20	XTAL	P37				
21	VSS					
22	EXTAL	P36				
23	VCC					
24		P35				NMI
25		P34		MTIOC0A/TMCI3/ POE2#	SCK6/SCK0	IRQ4
26		P33		MTIOC0D/TMRI3/ POE3#/TIOCD0	RXD6/SMISO6/SSCL6/ RXD0/SMISO0/SSCL0	IRQ3-DS
27		P32		MTIOC0C/TMO3/ TIOCC0	TXD6/SMOSI6/SSDA6/ TXD0/SMOSI0/SSDA0	IRQ2-DS/RTCOUT/ RTCIC2
28		P31		MTIOC4D/TMCI2	CTS1#/RTS1#/SS1#	IRQ1-DS/RTCIC1
29		P30		MTIOC4B/TMRI3/ POE8#	RXD1/SMISO1/SSCL1	IRQ0-DS/RTCIC0
30		P27	CS3#	MTIOC2B/TMCI3	SCK1	
31		P26	CS2#	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ CTS3#/RTS3#/SS3#	
32		P25	CS1#	MTIOC4C/MTCLKB/ TIOCA4	RXD3/SMISO3/SSCL3	ADTRG0#
33		P24	CS0#	MTIOC4A/MTCLKA/ TMRI1/TIOCB4	SCK3	
34		P23		MTIOC3D/MTCLKD/ TIOCD3	CTS0#/RTS0#/SS0#/ TXD3/SMOSI3/SSDA3	
35		P22		MTIOC3B/MTCLKC/ TMO0/TIOCC3	SCK0	
36		P21		MTIOC1B/TMCI0/ TIOCA3	RXD0/SMISO0/SSCL0	
37		P20		MTIOC1A/TMRI0/ TIOCB3	TXD0/SMOSI0/SSDA0	
38		P17		MTIOC3A/MTIOC3B/ TMO1/POE8#/TIOCB0/ TCLKD	SCK1/MISOA/SDA-DS/ TXD3/SMOSI3/SSDA3	IRQ7
39		P87		TIOCA2		

Table 1.12 List of Pins and Pin Functions (100-Pin LQFP) (1 / 3)

Pin No.	Power Supply, Clock, System Control	I/O Port	External Bus	Timers (MTU, TMR, POE)	Communications (SCIc, SCId, RSPI, RIIC)	Others
1	VREFH					
2		P03				DA0
3	VREFL					
4		PJ3		MTIOC3C	CTS6#/RTS6#/SS6#	
5	VCL					
6		PJ1		MTIOC3A		
7	MD					FINED
8	XCIN					
9	XCOUT					
10	RES#					
11	XTAL	P37				
12	VSS					
13	EXTAL	P36				
14	VCC					
15		P35				NMI
16		P34		MTIOC0A/TMCI3/ POE2#	SCK6	IRQ4
17		P33		MTIOC0D/TMRI3/ POE3#	RXD6/SMISO6/SSCL6	IRQ3-DS
18		P32		MTIOC0C/TMO3	TXD6/SMOSI6/SSDA6	IRQ2-DS/RTCOUT/ RTCIC2
19		P31		MTIOC4D/TMCI2	CTS1#/RTS1#/SS1#	IRQ1-DS/RTCIC1
20		P30		MTIOC4B/TMRI3/ POE8#	RXD1/SMISO1/SSCL1	IRQ0-DS/RTCIC0
21		P27	CS3#	MTIOC2B/TMCI3	SCK1	
22		P26	CS2#	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1	
23		P25	CS1#	MTIOC4C/MTCLKB		ADTRG0#
24		P24	CS0#	MTIOC4A/MTCLKA/ TMRI1		
25		P23		MTIOC3D/MTCLKD	CTS0#/RTS0#/SS0#	
26		P22		MTIOC3B/MTCLKC/ TMO0	SCK0	
27		P21		MTIOC1B/TMCI0	RXD0/SMISO0/SSCL0	
28		P20		MTIOC1A/TMRI0	TXD0/SMOSI0/SSDA0	
29		P17		MTIOC3A/MTIOC3B/ TMO1/POE8#	SCK1/MISOA/ SDA-DS	IRQ7
30		P16		MTIOC3C/MTIOC3D/ TMO2	TXD1/SMOSI1/SSDA1/ MOSIA/SCL-DS	IRQ6/RTCOUT/ ADTRG0#
31		P15		MTIOC0B/MTCLKB/ TMCI2	RXD1/SMISO1/SSCL1	IRQ5
32		P14		MTIOC3A/MTCLKA/ TMRI2	CTS1#/RTS1#/SS1#	IRQ4
33		P13		MTIOC0B/TMO3	SDA	IRQ3
34		P12		TMCI1	SCL	IRQ2
35		PH3		TMCI0		
36		PH2		TMRI0		IRQ1
37		PH1		TMO0		IRQ0
38		PH0				CACREF
39		P55	WAIT#	MTIOC4D/TMO3		
40		P54	ALE	MTIOC4B/TMCI1		
41	BCLK	P53				

Table 1.14 List of Pins and Pin Functions (69-Pin WLBGA) (2 / 2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TMR, POE)	Communications (SCIc, SCId, RSPI, RIIC)	Others
G3	NC				
G4		P54	MTIOC4B/TMCI1		
G5		PH1	TMO0		IRQ0
G6		P14	MTIOC3A/MTCLKA/TMRI2	CTS1#/RTS1#/SS1#	IRQ4
G7		P27	MTIOC2B/TMCI3	SCK1	
G8		P32	MTIOC0C/TMO3	TXD6/SMOSI6/SSDA6	IRQ2-DS/RTCOUT/ RTCIC2
G9		P35			NMI
H1		PB7	MTIOC3B	TXD9/SMOSI9/SSDA9	
H2		PC3	MTIOC4D	TXD5/SMOSI5/SSDA5	
H3		PC5	MTIOC3B/MTCLKD/TMRI2	SCK8/RSPCKA	
H4		PC6	MTIOC3C/MTCLKA/TMCI2	RXD8/SMISO8/SSCL8/MOSIA	
H5		P55	MTIOC4D/TMO3		
H6		PH3	TMCI0		
H7		P17	MTIOC3A/MTIOC3B/TMO1/ POE8#	SCK1/MISOA/SDA-DS	IRQ7
H8		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1	
H9		P30	MTIOC4B/TMRI3/POE8#	RXD1/SMISO1/SSCL1	IRQ0-DS/RTCIC0
J1	NC				
J2		PC2	MTIOC4B	RXD5/SMISO5/SSCL5/SSLA3	
J3		PC4	MTIOC3D/MTCLKC/TMCI1/ POE0#	SCK5/CTS8#/RTS8#/SS8#/ SSLA0	
J4		PC7	MTIOC3A/TMO2/MTCLKB	TXD8/SMOSI8/SSDA8/MISOA	CACREF
J5		PH0			CACREF
J6		PH2	TMRI0		IRQ1
J7		P15	MTIOC0B/MTCLKB/TMCI2	RXD1/SMISO1/SSCL1	IRQ5
J8		P16	MTIOC3C/MTIOC3D/TMO2	TXD1/SMOSI1/SSDA1/ MOSIA/SCL-DS	IRQ6/RTCOUT/ ADTRG0#
J9	NC				

Note: • Pin names to which –DS is appended are for pins that can be used to trigger release from deep software standby mode.
Note: • Leave the NC pin open.

Table 4.1 List of I/O Registers (Address Order) (8 / 29)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK < PCLK
0008 71D0h	ICU	DTC activation enable register 208	DTCER208	8	8	2 ICLK	
0008 71D3h	ICU	DTC activation enable register 211	DTCER211	8	8	2 ICLK	
0008 71D4h	ICU	DTC activation enable register 212	DTCER212	8	8	2 ICLK	
0008 71D7h	ICU	DTC activation enable register 215	DTCER215	8	8	2 ICLK	
0008 71D8h	ICU	DTC activation enable register 216	DTCER216	8	8	2 ICLK	
0008 71DBh	ICU	DTC activation enable register 219	DTCER219	8	8	2 ICLK	
0008 71DCh	ICU	DTC activation enable register 220	DTCER220	8	8	2 ICLK	
0008 71DFh	ICU	DTC activation enable register 223	DTCER223	8	8	2 ICLK	
0008 71E0h	ICU	DTC activation enable register 224	DTCER224	8	8	2 ICLK	
0008 71E3h	ICU	DTC activation enable register 227	DTCER227	8	8	2 ICLK	
0008 71E4h	ICU	DTC activation enable register 228	DTCER228	8	8	2 ICLK	
0008 71E7h	ICU	DTC activation enable register 231	DTCER231	8	8	2 ICLK	
0008 71E8h	ICU	DTC activation enable register 232	DTCER232	8	8	2 ICLK	
0008 71EBh	ICU	DTC activation enable register 235	DTCER235	8	8	2 ICLK	
0008 71ECh	ICU	DTC activation enable register 236	DTCER236	8	8	2 ICLK	
0008 71EFh	ICU	DTC activation enable register 239	DTCER239	8	8	2 ICLK	
0008 71F0h	ICU	DTC activation enable register 240	DTCER240	8	8	2 ICLK	
0008 71F7h	ICU	DTC activation enable register 247	DTCER247	8	8	2 ICLK	
0008 71F8h	ICU	DTC activation enable register 248	DTCER248	8	8	2 ICLK	
0008 71FBh	ICU	DTC activation enable register 251	DTCER251	8	8	2 ICLK	
0008 71FCh	ICU	DTC activation enable register 252	DTCER252	8	8	2 ICLK	
0008 7202h	ICU	Interrupt request enable register 02	IER02	8	8	2 ICLK	
0008 7203h	ICU	Interrupt request enable register 03	IER03	8	8	2 ICLK	
0008 7204h	ICU	Interrupt request enable register 04	IER04	8	8	2 ICLK	
0008 7205h	ICU	Interrupt request enable register 05	IER05	8	8	2 ICLK	
0008 7207h	ICU	Interrupt request enable register 07	IER07	8	8	2 ICLK	
0008 7208h	ICU	Interrupt request enable register 08	IER08	8	8	2 ICLK	
0008 720Bh	ICU	Interrupt request enable register 0B	IER0B	8	8	2 ICLK	
0008 720Ch	ICU	Interrupt request enable register 0C	IER0C	8	8	2 ICLK	
0008 720Dh	ICU	Interrupt request enable register 0D	IER0D	8	8	2 ICLK	
0008 720Eh	ICU	Interrupt request enable register 0E	IER0E	8	8	2 ICLK	
0008 720Fh	ICU	Interrupt request enable register 0F	IER0F	8	8	2 ICLK	
0008 7210h	ICU	Interrupt request enable register 10	IER10	8	8	2 ICLK	
0008 7211h	ICU	Interrupt request enable register 11	IER11	8	8	2 ICLK	
0008 7212h	ICU	Interrupt request enable register 12	IER12	8	8	2 ICLK	
0008 7213h	ICU	Interrupt request enable register 13	IER13	8	8	2 ICLK	
0008 7214h	ICU	Interrupt request enable register 14	IER14	8	8	2 ICLK	
0008 7215h	ICU	Interrupt request enable register 15	IER15	8	8	2 ICLK	
0008 7216h	ICU	Interrupt request enable register 16	IER16	8	8	2 ICLK	
0008 7217h	ICU	Interrupt request enable register 17	IER17	8	8	2 ICLK	
0008 7218h	ICU	Interrupt request enable register 18	IER18	8	8	2 ICLK	
0008 7219h	ICU	Interrupt request enable register 19	IER19	8	8	2 ICLK	
0008 721Ah	ICU	Interrupt request enable register 1A	IER1A	8	8	2 ICLK	
0008 721Bh	ICU	Interrupt request enable register 1B	IER1B	8	8	2 ICLK	
0008 721Ch	ICU	Interrupt request enable register 1C	IER1C	8	8	2 ICLK	
0008 721Dh	ICU	Interrupt request enable register 1D	IER1D	8	8	2 ICLK	
0008 721Eh	ICU	Interrupt request enable register 1E	IER1E	8	8	2 ICLK	
0008 721Fh	ICU	Interrupt request enable register 1F	IER1F	8	8	2 ICLK	
0008 72E0h	ICU	Software interrupt activation register	SWINTR	8	8	2 ICLK	
0008 72F0h	ICU	Fast interrupt set register	FIR	16	16	2 ICLK	
0008 7300h	ICU	Interrupt source priority register 000	IPR000	8	8	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (22 / 29)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles: ICLK ≥ PCLK	Number of Access Cycles: ICLK < PCLK
0008 C000h	PORT0	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C001h	PORT1	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C002h	PORT2	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C003h	PORT3	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C004h	PORT4	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C005h	PORT5	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C006h	PORT6	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C007h	PORT7	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C008h	PORT8	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C009h	PORT9	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C00Ah	PORTA	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C00Bh	PORTB	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C00Ch	PORTC	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C00Dh	PORTD	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C00Eh	PORTE	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C00Fh	PORTF	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C011h	PORTH	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C012h	PORTJ	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C013h	PORTK	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C014h	PORTL	Port direction register	PDR	8	8	2, 3 PCLKB	2 ICLK
0008 C020h	PORT0	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C021h	PORT1	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C022h	PORT2	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C023h	PORT3	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C024h	PORT4	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C025h	PORT5	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C026h	PORT6	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C027h	PORT7	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C028h	PORT8	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C029h	PORT9	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C02Ah	PORTA	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C02Bh	PORTB	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C02Ch	PORTC	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C02Eh	PORTE	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C02Fh	PORTF	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C031h	PORTH	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C032h	PORTJ	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C033h	PORTK	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C034h	PORTL	Port output data register	PODR	8	8	2, 3 PCLKB	2 ICLK
0008 C040h	PORT0	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing
0008 C041h	PORT1	Port input data register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing	3 ICLK cycles when reading, 2 ICLK cycles when writing

Table 4.1 List of I/O Registers (Address Order) (25 / 29)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles: ICLK ≥ PCLK	Number of Access Cycles: ICLK < PCLK
0008 C080	PORT0	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C082h	PORT1	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C083h	PORT1	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C084h	PORT2	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C085h	PORT2	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C086h	PORT3	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C087h	PORT3	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C08Ch	PORT6	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C08Eh	PORT7	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C08Fh	PORT7	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C090h	PORT8	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C092h	PORT9	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C094h	PORTA	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C095h	PORTA	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C096h	PORTB	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C097h	PORTB	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C098h	PORTC	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C099h	PORTC	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C09Ch	PORTE	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C09Dh	PORTE	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C0A6h	PORTK	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C0A7h	PORTK	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK
0008 C0C0h	PORT0	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0C1h	PORT1	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0C2h	PORT2	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0C3h	PORT3	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0C4h	PORT4	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0C5h	PORT5	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0C6h	PORT6	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0C7h	PORT7	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0C8h	PORT8	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0C9h	PORT9	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0CAh	PORTA	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0CBh	PORTB	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0CCh	PORTC	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0CDh	PORTD	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0CEh	PORTE	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0CFh	PORTF	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0D1h	PORTH	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0D2h	PORTJ	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0D3h	PORTK	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0D4h	PORTL	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0E0h	PORT0	Drive capacity control register	DSCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0E1h	PORT1	Drive capacity control register	DSCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0E2h	PORT2	Drive capacity control register	DSCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0E3h	PORT3	Drive capacity control register	DSCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0E5h	PORT5	Drive capacity control register	DSCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0E6h	PORT6	Drive capacity control register	DSCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0E7h	PORT7	Drive capacity control register	DSCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0E8h	PORT8	Drive capacity control register	DSCR	8	8	2, 3 PCLKB	2 ICLK
0008 C0E9h	PORT9	Drive capacity control register	DSCR	8	8	2, 3 PCLKB	2 ICLK

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Conditions: VSS = AVSS0 = VREFL = VREFL0 = 0 V

Item	Symbol	Value	Unit
Power supply voltage	VCC	–0.3 to +6.5	V
Input voltage (except for ports for 5 V tolerant*1)	V_{in}	–0.3 to VCC +0.3*3	V
Input voltage (ports for 5 V tolerant*1)	V_{in}	–0.3 to +6.5	V
Reference power supply voltage	VREFH, VREFH0	–0.3 to VCC +0.3*3	V
Analog power supply voltage	AVCC0*2	–0.3 to +6.5	V
Analog input voltage	V_{AN}	–0.3 to VCC +0.3*3	V
Operating temperature	T_{opr}	–40 to +105	°C
Storage temperature	T_{stg}	–55 to +125	°C

Caution: Permanent damage to the LSI may result if absolute maximum ratings are exceeded.

To preclude any malfunctions due to noise interferences, insert capacitors of high frequency characteristics between the VCC and VSS pins, between the AVCC0 and AVSS0 pins, and between the VREFH0 and VREFL0 pins. Place capacitors of 0.1 µF or so as close to every power pin and use the shortest and heaviest possible traces.

Connect the VCL pin to a VSS pin via a 0.1 µF (±20% accuracy) capacitor. The capacitor must be placed as close to the pin as possible.

Note 1. Ports 12, 13, 16, and 17 are 5 V tolerant.

Note 2. Connect AVCC0 to VCC. When neither the A/D converter nor the D/A converter is in use, do not leave the AVCC0, VREFH, VREFH0, AVSS0, VREFL, and VREFL0 pins open. Connect the AVCC0, VREFH, and VREFH0 pins to VCC, and the AVSS0, VREFL, and VREFL0 pins to VSS, respectively.

Note 3. The maximum value is 6.5 V.

5.2 DC Characteristics

Table 5.2 DC Characteristics (1)

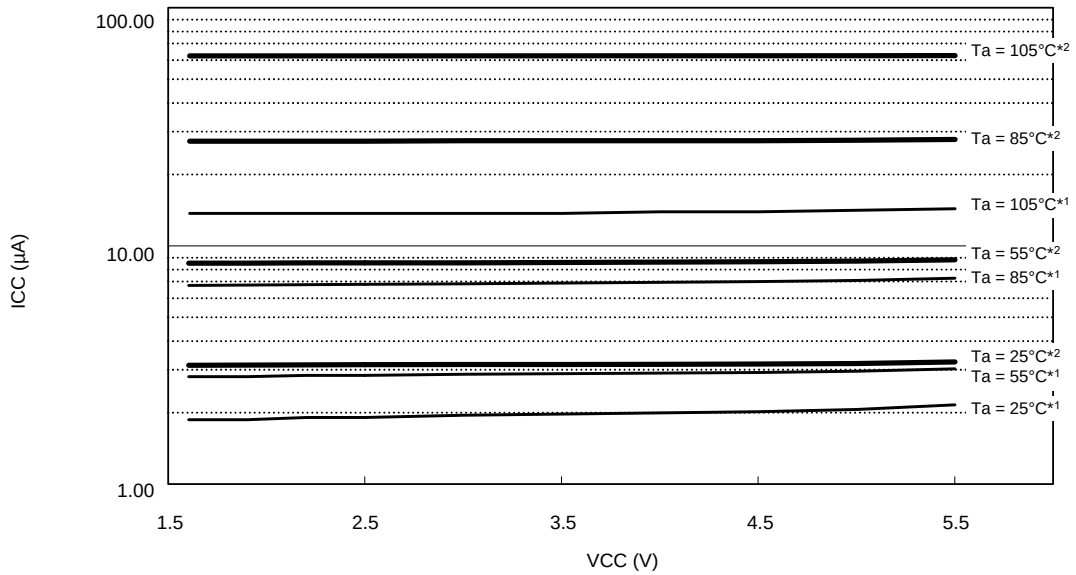
Conditions: VCC = AVCC0 = 2.7 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	RIIC input pin (except for SMBus, 5 V tolerant)	V_{IH}	VCC × 0.7	—	5.8	V	
	Ports 12, 13, 16, and 17 (5 V tolerant)		VCC × 0.8	—	5.8		
	Ports 0, 14, 15, 2 to 9, A to L, and RES#		VCC × 0.8	—	VCC + 0.3		
	RIIC input pin (except for SMBus)	V_{IL}	–0.3	—	VCC × 0.3		
	Other than RIIC input pin		–0.3	—	VCC × 0.2		
	RIIC input pin (except for SMBus)	ΔV_T	VCC × 0.05	—	—		
	Other than RIIC input pin		VCC × 0.1	—	—		
Input level voltage (except for Schmitt trigger input pins)	MD pin	V_{IH}	VCC × 0.9	—	VCC + 0.3	V	
	EXTAL, WAIT#		VCC × 0.8	—	VCC + 0.3		
	D0 to D15		VCC × 0.7	—	VCC + 0.3		
	RIIC input pin (SMBus)		2.1	—	VCC + 0.3		
	MD pin	V_{IL}	–0.3	—	VCC × 0.1		
	EXTAL, WAIT#		–0.3	—	VCC × 0.2		
	D0 to D15		–0.3	—	VCC × 0.3		
	RIIC input pin (SMBus)		–0.3	—	0.8		

Table 5.3 DC Characteristics (2)

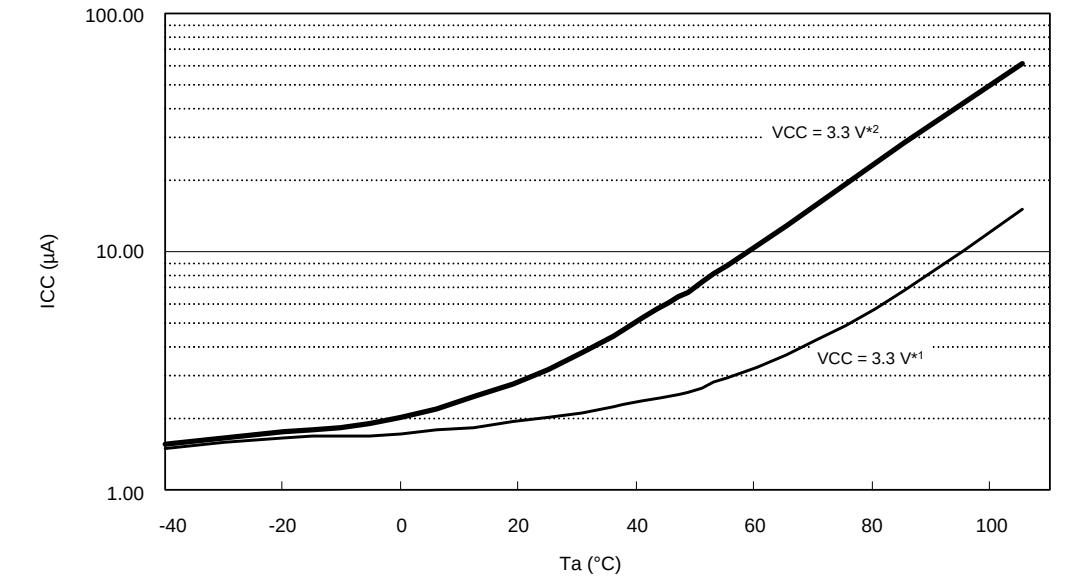
Conditions: VCC = AVCC0 = 1.62 to 2.7 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	Ports 12, 13, 16, and 17 (5 V tolerant)		V_{IH}	VCC × 0.8	—	5.8	V	
	Ports 0, 14, 15, 2 to 9, A to L, and RES#			VCC × 0.8	—	VCC + 0.3		
	All input pins		V_{IL}	–0.3	—	VCC × 0.2		
	Ports 0 to 9, A to L	VCC ≥ 2.2V	ΔV_T	VCC × 0.05	—	—		
		VCC < 2.2V		VCC × 0.01				
	RES#			VCC × 0.1				
Input level voltage (except for Schmitt trigger input pins)	MD pin		V_{IH}	VCC × 0.9	—	VCC + 0.3	V	
	EXTAL, WAIT#			VCC × 0.8	—	VCC + 0.3		
	D0 to D15			VCC × 0.7	—	VCC + 0.3		
	MD pin		V_{IL}	–0.3	—	VCC × 0.1		
	EXTAL, WAIT#			–0.3	—	VCC × 0.2		
	D0 to D15			–0.3	—	VCC × 0.3		



Note 1. Average value of the tested middle samples during product evaluation.
Note 2. Average value of the tested upper-limit samples during product evaluation.

Figure 5.13 Voltage Dependency in Software Standby Mode (SOFTCUT[2:0] Bits = 111b) (Reference Data) for Chip Version C



Note 1. Average value of the tested middle samples during product evaluation.
Note 2. Average value of the tested upper-limit samples during product evaluation.

Figure 5.14 Temperature Dependency in Software Standby Mode (SOFTCUT[2:0] Bits = 111b) (Reference Data) for Chip Version C

[Chip version B with 256 Kbytes or less of flash memory and 48 to 100 pins]

Table 5.12 DC Characteristics (11)

Conditions: VCC = AVCC0 = 2.7 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

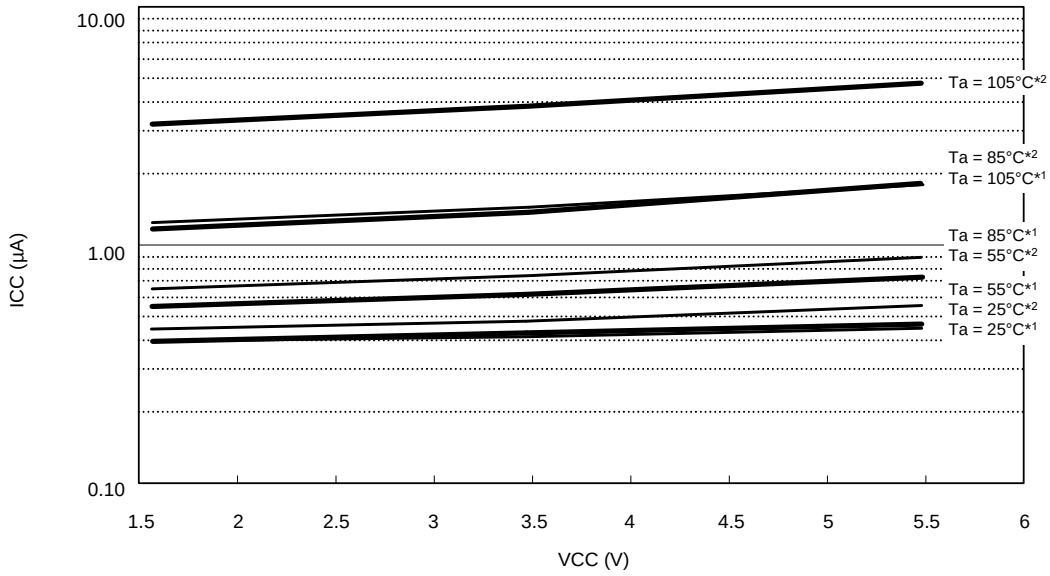
Item					Symbol	Typ.	Max.	Unit	Test Conditions
Supply current*1	High-speed operating mode	Normal operating mode	No peripheral operation*2	ICLK = 50 MHz	I_{CC}	7.2	—	mA	
			All peripheral operation: Normal*3	ICLK = 50 MHz		23.5	—		
			All peripheral operation: Max.*3	ICLK = 50 MHz		—	45		
		Sleep mode	No peripheral operation	ICLK = 50 MHz		4.3	—		
			All peripheral operation: Normal	ICLK = 50 MHz		12	—		
		All-module clock stop mode		ICLK = 50 MHz		3.7	—		
		Increase during BGO operation*4				20	—		

Note 1. Supply current values do not include output charge/discharge current from all pins. The values apply when internal pull-up MOSs are in the off state.

Note 2. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is PLL and the VCO oscillation frequency is 100 MHz. BCLK, FCLK, and PCLK are set to divided by 64.

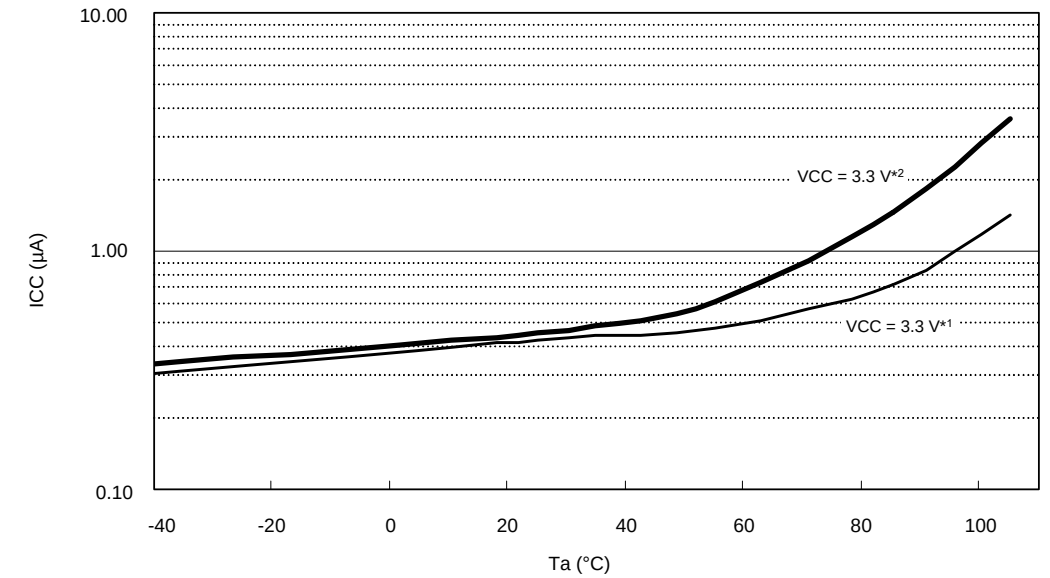
Note 3. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is PLL and the VCO oscillation frequency is 100 MHz. BCLK, FCLK, and PCLK are ICLK divided by 2.

Note 4. This is the increase if data is programmed to or erasing from the ROM or E2 DataFlash during program execution.



Note 1. Average value of the tested middle samples during product evaluation.
Note 2. Average value of the tested upper-limit samples during product evaluation.

Figure 5.24 Voltage Dependency in Deep Software Standby Mode (DEEPCUT1 Bit = 1) (Reference Data) for Chip Version B with 256 Kbytes or Less of Flash Memory and 48 to 100 Pins



Note 1. Average value of the tested middle samples during product evaluation.
Note 2. Average value of the tested upper-limit samples during product evaluation.

Figure 5.25 Temperature Dependency in Deep Software Standby Mode (DEEPCUT1 Bit = 1) (Reference Data) for Chip Version B with 256 Kbytes or Less of Flash Memory and 48 to 100 Pins

Item					Symbol	Typ.	Max.	Unit	Test Conditions
Supply current*1	Low-speed operating mode 1	Normal operating mode	No peripheral operation*7	ICLK = 8 MHz	I_{CC}	2.1	—	mA	
				ICLK = 4 MHz		1.7	—		
				ICLK = 2 MHz		1.5	—		
			All peripheral operation: Normal*8	ICLK = 8 MHz		7.3	—		
				ICLK = 4 MHz		4.5	—		
				ICLK = 2 MHz		3.1	—		
			All peripheral operation: Max.*7	ICLK = 8 MHz		—	12		
				ICLK = 4 MHz		—	—		
				ICLK = 2 MHz		—	—		
		Sleep mode	No peripheral operation	ICLK = 8 MHz		1.5	—		
				ICLK = 4 MHz		1.4	—		
				ICLK = 2 MHz		1.3	—		
			All peripheral operation: Normal	ICLK = 8 MHz		4.1	—		
				ICLK = 4 MHz		3.0	—		
				ICLK = 2 MHz		2.3	—		
		All-module clock stop mode		ICLK = 8 MHz		1.4	—		
				ICLK = 4 MHz		1.3	—		
				ICLK = 2 MHz		1.2	—		
	Low-speed operating mode 2	Normal operating mode	No peripheral operation*9	ICLK = 32 kHz		0.022	—		
			All peripheral operation: Normal*10	ICLK = 32 kHz		0.06	—		
			All peripheral operation: Max.*10	ICLK = 32 kHz		—	3*11		
		Sleep mode	No peripheral operation	ICLK = 32 kHz		0.017	—		
			All peripheral operation: Normal	ICLK = 32 kHz		0.036	—		
		All-module clock stop mode				0.017	—		

Note 1. Supply current values do not include output charge/discharge current from all pins. The values apply when internal pull-up MOSs are in the off state.
Note 2. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is PLL and the VCO oscillation frequency is 64 MHz. BCLK, FCLK, and PCLK are set to divided by 64.
Note 3. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is HOCO and the oscillation frequency is 40 MHz. BCLK, FCLK, and PCLK are set to divided by 64.
Note 4. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is PLL and the VCO oscillation frequency is 64 MHz. BCLK, FCLK, and PCLK are ICLK divided by 1.
Note 5. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is HOCO and the oscillation frequency is 40 MHz. BCLK, FCLK, and PCLK are ICLK divided by 1.
Note 6. This is the increase if data is programmed to or erasing from the ROM or E2 DataFlash during program execution.
Note 7. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is HOCO and the oscillation frequency is 32 MHz. BCLK, FCLK, and PCLK are set to divided by 64.
Note 8. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is HOCO and the oscillation frequency is 32 MHz. BCLK, FCLK, and PCLK are ICLK divided by 1.
Note 9. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is the sub oscillation circuit. BCLK, FCLK, and PCLK are set to divided by 64.
Note 10. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is the sub oscillation circuit. BCLK, FCLK, and PCLK are ICLK divided by 1.
Note 11. Value when the main clock continues oscillating at 12.5 MHz.

Note 2. When specifying the main clock oscillator stabilization time, load the MOSCWTCR register with a stabilization time value that is greater than the resonator-vendor-recommended value. When determining the main lock oscillation stabilization wait time, allow an adequate margin (2 times is recommended) for the main clock oscillation stabilization time.
Start using the main clock in the main clock oscillation stabilization wait time (tMAINOSCWT) after setting up the main clock oscillator for operation with the MOSCCR.MOSTP bit.
The indicated value is a reference value that is measured for an 8 MHz resonator.
Note 3. Sum of the main clock oscillation stabilization time and the PLL oscillation stabilization time.
Note 4. The indicated value is a reference value that is measured for an 8 MHz resonator.
Note 5. When specifying the sub-clock oscillation stabilization time, load the SOSCWTCR register with the resonator-vendor-recommended stabilization time value minus 2 seconds. When determining the sub-clock oscillation stabilization wait time, allow an adequate margin (2 times is recommended) for the sub-clock oscillation stabilization time. Start using the sub-clock in the sub-clock oscillation stabilization wait time (tSUBOSCWT) after setting up the sub-clock oscillator for operation with the SOSCCR.SOSTP or RCR3.RTCEN bit.
Note 6. There is no minimum or maximum value for 69-pin WLBGA.
Note 7. Characteristic value before mounting on the board for 69-pin WLBGA.

Table 5.51 Bus Timing (3)

Conditions: VCC = AVCC0 = 1.62 to 1.8 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V,
fBCLK ≤ 12 MHz (BCLK pin output frequency ≤ 6 MHz), T_a = –40 to +105°C, V_{OH} = VCC × 0.5,
V_{OL} = VCC × 0.5, I_{OH} = –0.5 mA, I_{OL} = 0.5 mA, C_L = 30 pF
When normal output is selected by the drive capacity register

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	125	ns	Figure 5.76 to Figure 5.79
Byte control delay time	t_{BCD}	—	125	ns	
CS# delay time	t_{CSD}	—	125	ns	
RD# delay time	t_{RSD}	—	125	ns	
Read data setup time	t_{RDS}	85	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	125	ns	
Write data delay time	t_{WDD}	—	125	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	85	—	ns	Figure 5.80
WAIT# hold time	t_{WTH}	0	—	ns	

Table 5.59 Timing of On-Chip Peripheral Modules (5)

Conditions: VCC = AVCC0 = 2.7 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, fPCLKB = up to 32 MHz,
T_a = –40 to +105°C

Item		Symbol	Min.*1,*2	Max.	Unit	Test Conditions
RIIC (Standard mode, SMBus)	SCL input cycle time	t_{SCL}	6 (12) × t_{IICcyc} + 1300	—	ns	Figure 5.98
	SCL input high pulse width	t_{SCLH}	3 (6) × t_{IICcyc} + 300	—	ns	
	SCL input low pulse width	t_{SCLL}	3 (6) × t_{IICcyc} + 300	—	ns	
	SCL, SDA input rise time	t_{Sr}	—	1000	ns	
	SCL, SDA input fall time	t_{Sf}	—	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1 (4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3 (6) × t_{IICcyc} + 300	—	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 300	—	ns	
	Restart condition input setup time	t_{STAS}	1000	—	ns	
	Stop condition input setup time	t_{STOS}	1000	—	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	
RIIC (Fast mode)	SCL input cycle time	t_{SCL}	6 (12) × t_{IICcyc} + 600	—	ns	Figure 5.98
	SCL input high pulse width	t_{SCLH}	3 (6) × t_{IICcyc} + 300	—	ns	
	SCL input low pulse width	t_{SCLL}	3 (6) × t_{IICcyc} + 300	—	ns	
	SCL, SDA input rise time	t_{Sr}	20 + 0.1C_b	300	ns	
	SCL, SDA input fall time	t_{Sf}	20 + 0.1C_b	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1 (4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3 (6) × t_{IICcyc} + 300	—	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 300	—	ns	
	Restart condition input setup time	t_{STAS}	300	—	ns	
	Stop condition input setup time	t_{STOS}	300	—	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	

Note: • t_{IICcyc}: RIIC internal reference count clock (IICφ) cycle
Note 1. The value in parentheses is used when the ICMR3.NF[1:0] bits are set to 11b while a digital filter is enabled with the ICFER.NFE bits = 1.
Note 2. C_b indicates the total capacity of the bus line.

Table 5.66 Sampling Time

Conditions: VCC = AVCC0 = 1.62 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item		Symbol	Typ.	Unit	Test Conditions
Sampling time	High-precision channel	Ts	0.2 + 0.14 × R0 (KΩ)	µs	Figure 5.100
	Normal-precision channel		0.35 + 0.14 × R0 (KΩ)		

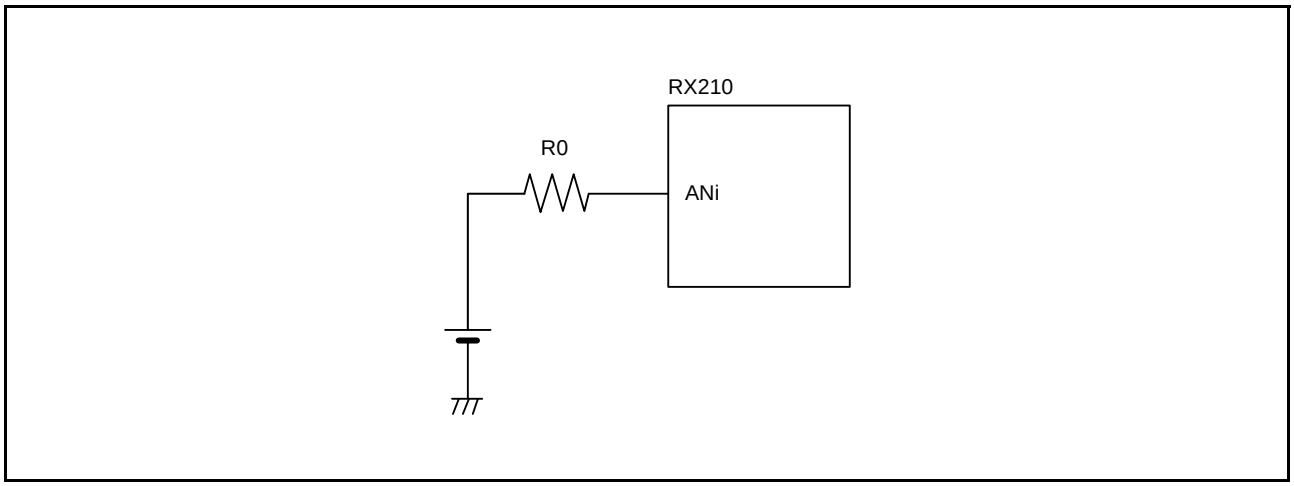


Figure 5.100 Internal Equivalent Circuit of Analog Input Pin

5.5 D/A Conversion Characteristics

Table 5.67 D/A Conversion Characteristics (1)

Conditions: VCC = AVCC0 = 2.7 to 5.5 V, VREFH = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL = VREFL0 = 0 V, fPCLKB = up to 32 MHz, T_a = –40 to +105°C

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	—	—	10	Bit	
Conversion time	—	—	3.0	µs	20-pF capacitive load
Absolute accuracy	—	±3.0	±5.0	LSB	4-MΩ resistive load
	—	—	±4.0	LSB	8-MΩ resistive load
RO output resistance	—	4.1	—	kΩ	

Table 5.68 D/A Conversion Characteristics (2)

Conditions: VCC = AVCC0 = 2.7 to 5.5 V, VREFH =1.8 V to AVCC0,
VSS = AVSS0 = VREFL = VREFL0 = 0 V, fPCLKB = up to 32 MHz, T_a = –40 to +105°C

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	—	—	10	Bit	
Conversion time	—	—	10.0	µs	20-pF capacitive load
Absolute accuracy	—	±5.0	±6.0	LSB	4-MΩ resistive load
	—	—	±5.0	LSB	8-MΩ resistive load
RO output resistance	—	4.1	—	kΩ	

5.6 Temperature Sensor Characteristics

Table 5.69 Temperature Sensor Characteristics

Conditions: VCC = AVCC0 = VREFH0 = 1.8 to 5.5 V, VSS = AVSS0 = VREFL = VREFL0 = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Relative accuracy		—	—	±1.0	—	°C	
Temperature slope	1.8 ≤ AVCC0 < 2.7	—	—	7.27	—	mV/°C	PGAGAIN = 00b
	2.7 ≤ AVCC0 < 3.6		—	10.46	—		PGAGAIN = 01b
	3.6 ≤ AVCC0 < 4.5		—	13.98	—		PGAGAIN = 10b
	4.5 ≤ AVCC0 ≤ 5.5		—	21.65	—		PGAGAIN = 11b
Output voltage (@ 25°C)		—	—	1.375	—	V	VCC = 3.6 V
Temperature sensor start time		t_{START}	—	—	80	µs	Figure 5.102
Sampling time		—	30	72	300	µs	
PGA restart time		t_{RST_PGA}	—	—	40	µs	

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